TOSHIBA Field Effect Transistor Silicon N Channel MOS Type

# SSM3K37CT

- High Speed Switching Applications
- Analog Switch Applications
- 1.5Vdrive
- Low ON-resistance  $R_{DS(ON)} = 5.60 \Omega (max) (@V_{GS} = 1.5 V)$ 
  - $R_{DS(ON)}$  = 4.05 Ω (max) (@V<sub>GS</sub> = 1.8 V)  $R_{DS(ON)}$  = 3.02 Ω (max) (@V<sub>GS</sub> = 2.5 V)

 $R_{DS(ON)} = 2.20 \text{ (max)} (@V_{CS} = 4.5 \text{ V})$ 

 $R_{DS(ON)} = 2.20 \ \Omega \ (max) \ (@V_{GS} = 4.5 \ V)$ 

#### Absolute Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit	
Drain-Source voltage		V <sub>DSS</sub>	20	V	
Gate-Source voltage		V <sub>GSS</sub>	± 10	V	
Drain current	DC	۱ <sub>D</sub>	200	mA	
	Pulse	I <sub>DP</sub>	400		
Power dissipation		P <sub>D</sub> (Note1)	100	mW	
Channel temperature		T <sub>ch</sub>	150	°C	
Storage temperature range		T <sub>stg</sub>	–55 to 150	°C	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the

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0.6±0.05

Weight: 0.75mg(typ.)

Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

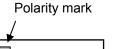
Note 1: Mounted on FR4 board

 $(10 \text{ mm} \times 10 \text{ mm} \times 1.0 \text{ mm}, \text{Cu Pad}: 100 \text{ mm}^2)$ 

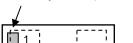
### Marking(top view)

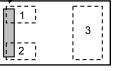
### Pin Condition (top view)

Polarity mark (on the top)



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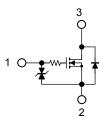




1. Gate 2. Source

- 2. Sourd 3. Drain
- \*Electrodes: On the bottom

**Equivalent Circuit** 



Start of commercial production 2010-11

1

Unit : mm

Electrical Characteristics (Ta = 25°C)

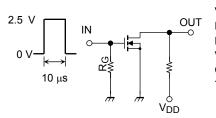
Char	acteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Drain-source breakdown voltage	V (BR) DSS	$I_D = 1 \text{ mA}, V_{GS} = 0 \text{ V}$	20	_	_	V	
Drain-source breakdown vollage		V (BR) DSX	$I_D = 1 \text{ mA}, V_{GS} = -10 \text{ V}$	12			_
Drain cut-off curre	ent	IDSS	$V_{DS} = 20 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	_		1	μA
Gate leakage curr	ent	I <sub>GSS</sub>	$V_{GS}=\pm 10~V,~V_{DS}=0~V$	_		±1	μA
Gate threshold vo	Itage	V <sub>th</sub>	$V_{DS} = 3 V, I_D = 1 mA$	0.35		1.0	V
Forward transfer a	admittance	Y <sub>fs</sub>	$V_{DS} = 3 V, I_D = 100 mA$ (Note2)	0.14	0.28	_	S
Drain-source ON-resistance		$I_D = 100 \text{ mA}, V_{GS} = 4.5 \text{ V}$ (Note2)	_	1.65	2.20	Ω	
	Deserver	$I_D = 50 \text{ mA}, V_{GS} = 2.5 \text{ V}$ (Note2)	_	2.16	3.02		
	R <sub>DS (ON)</sub>	$I_D = 20 \text{ mA}, V_{GS} = 1.8 \text{ V}$ (Note2)	_	2.66	4.05		
			$I_D = 10 \text{ mA}, V_{GS} = 1.5 \text{ V}$ (Note2)	_	3.07		5.60
Input capacitance		C <sub>iss</sub>	V <sub>DS</sub> = 10 V, V <sub>GS</sub> = 0 V, f = 1 MHz	_	12	_	pF
Output capacitance Reverse transfer capacitance		C <sub>oss</sub>		_	5.5	_	
		C <sub>rss</sub>		_	4.1	_	
Switching time	Turn-on time	t <sub>on</sub>	$V_{DD} = 10 \text{ V}, \text{ I}_{D} = 100 \text{ mA}$	_	18	_	ns
	Turn-off time	t <sub>off</sub>	$V_{GS}$ = 0 to 2.5 V, $R_{G}$ = 50 $\Omega$	_	36	_	
Drain-Source forw	ard voltage	V <sub>DSF</sub>	$I_D = -200 \text{ mA}, V_{GS} = 0 \text{ V}$ (Note2)	_	-0.89	-1.2	V

(b) V<sub>IN</sub>

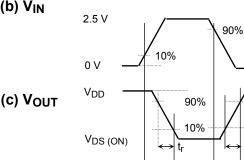
Note2: Pulse test

#### Switching Time Test Circuit

(a) Test Circuit







### Precaution

Let V<sub>th</sub> be the voltage applied between gate and source that causes the drain current (I<sub>D</sub>) to be low (1mA for the SSM3K37CT). Then, for normal switching operation, V<sub>GS(on)</sub> must be higher than V<sub>th</sub>, and V<sub>GS(off)</sub> must be lower than Vth. This relationship can be expressed as: VGS(off) < Vth < VGS(on).

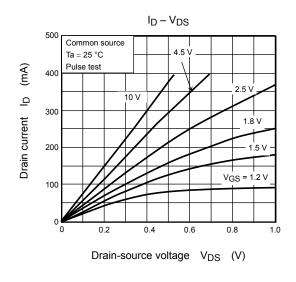
Take this into consideration when using the device.

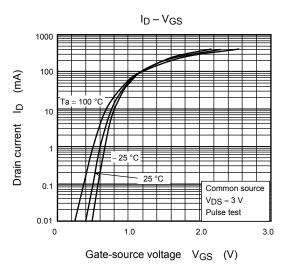
### **Handling Precaution**

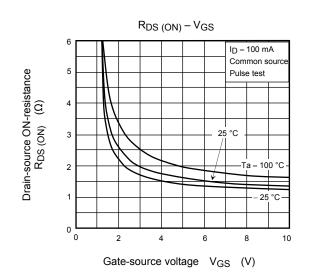
When handling individual devices that are not yet mounted on a circuit board, make sure that the environment is protected against electrostatic discharge. Operators should wear antistatic clothing, and containers and other objects that come into direct contact with devices should be made of antistatic materials.

Thermal resistance Rth (ch-a) and power dissipation PD vary depending on board material, board area, board thickness and pad area. When using this device, please take heat dissipation into consideration

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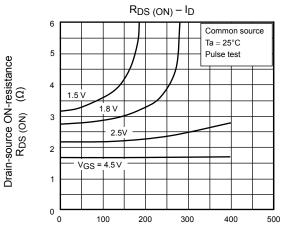
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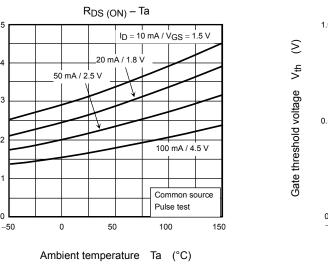
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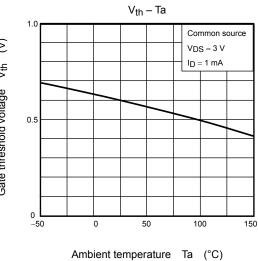
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Drain-source ON-resistance RDs (ON)  $(\Omega)$ 

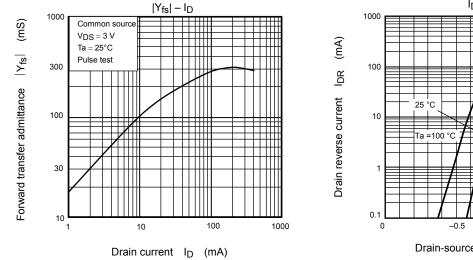


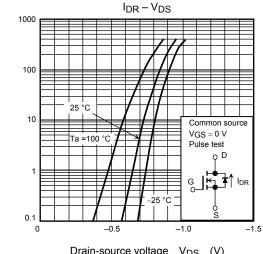


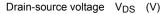


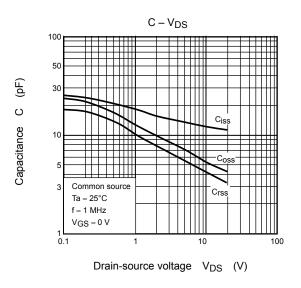


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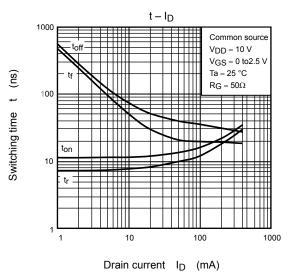








P<sub>D</sub> – Ta Mounted FR4 board (10 mm  $\times$  10 mm  $\times$  1.0mm Cu Pad: 100 mm  $^2$  ) Power dissipation PD (mW) 0 Ambient temperature Ta (°C)



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